

# Industry Council on ESD Target Levels

## Roster



# Organization of Council

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  - The CORE TEAM are expected to:
    - Regularly attend all conference calls (monthly)
    - Prepare publications
    - Collect and discuss data
    - Make presentations to outside standardization bodies
  - All other MEMBERS can expect:
    - Receiving agenda and minutes of the conference calls
    - Opportunity to provide input to the chairmen before the teleconferences
    - Review of publications before release
    - Invitation to attend general face-to-face meetings (~twice a year)
- Core Team members will be selected by the chairmen based on their active participation and contributions during the last few months

# List of Members

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Robert Ashton, ON Semiconductor  
Jon Barth, Barth Electronics  
Stephen Beebe, AMD  
Colin Bolger, VIA Technologies  
Brett Carn, Intel  
Michael Chaine, Micron  
Stephanie Dournelle, ST  
Charvaka Duvvury\*, TI (chairman)  
Ted Dangelmayer, Dangelmayer Associates  
Melanie Etherton, Freescale  
Yasuhiro Fukuda, OKI Engineering  
Reinhold Gärtner, Infineon  
Robert Gauthier, IBM  
Ron Gibson, Celestica  
Horst Gieser, FhG IZM  
Harald Gossner\*, Infineon (chairman)  
Leo G. Henry, ESD/TLP Consulting  
Kelvin Hsueh, UMC  
Hiroyasu Ishizuka, Renesas  
Satoshi Isofuku, Tokyo Electronics  
Natarajan Mahadeva Iyer, Chartered  
Marty Johnson, National Semiconductors  
Larry Johnson, LSI  
Michael Jones, SUN  
ChangSu Kim, Samsung

John Kinnear, IBM  
Marcus Koh, Everfeed  
Alan Liang, TSMC  
Brian Langley, SUN  
Timothy Maloney, Intel  
David Mendez, Solectron  
Tom Meuse, Thermo Fisher Scientific  
James Miller, Freescale  
Homi Nariman, AMD  
Roger Peirce, Simco  
Nate Peachey, RFMD  
Joachim Reiner, AustriaMicroSystems  
Alan Righter, Analog Devices  
Donna Robinson-Hahn, Fairchild Semiconductor  
Theo Smedes, NXP Semiconductors  
Bart Sorgeloos, Sarnoff Europe  
Arnold Steinman, MKS Ion Systems  
Teruo Suzuki, Fujitsu  
David E. Swenson, Affinity Static Control Consulting  
Benjamin Van Camp, Sarnoff Europe  
Koen Verhaege, Sarnoff Europe  
Tetsuaki Wada, Matsushita Electric Industrial  
Nobuyuki Wakai, Toshiba

# Core Team

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**\*) Chairmen**